

2SK1838(L), 2SK1838(S)

Silicon N-Channel MOS FET

HITACHI

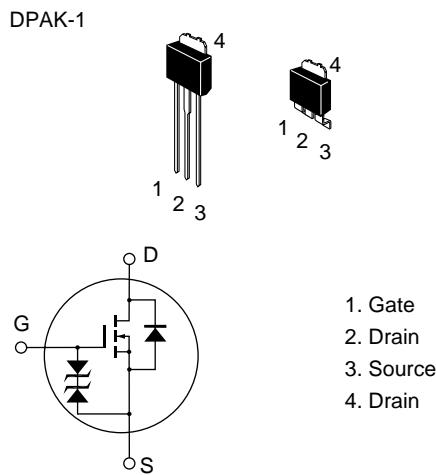
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switchingregulator, DC-DC converter

Outline



2SK1838(L), 2SK1838(S)

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	250	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	1	A
Drain peak current	I _{D(pulse)} ^{*1}	2	A
Body to drain diode reverse drain current	I _{DR}	1	A
Channel dissipation	Pch ^{*2}	10	W
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

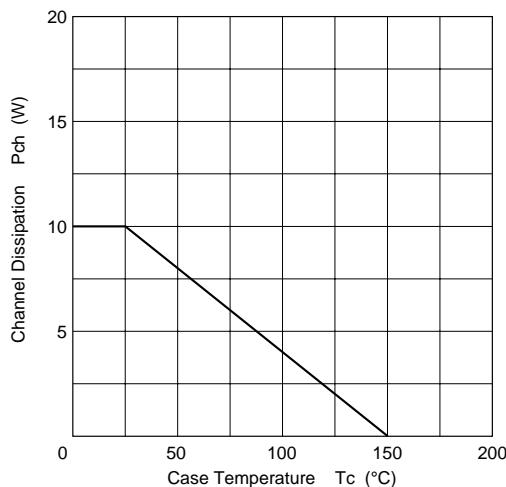
Notes 1. PW 10 µs, duty cycle 1 %
 2. Value at Tc = 25 °C

Electrical Characteristics (Ta = 25°C)

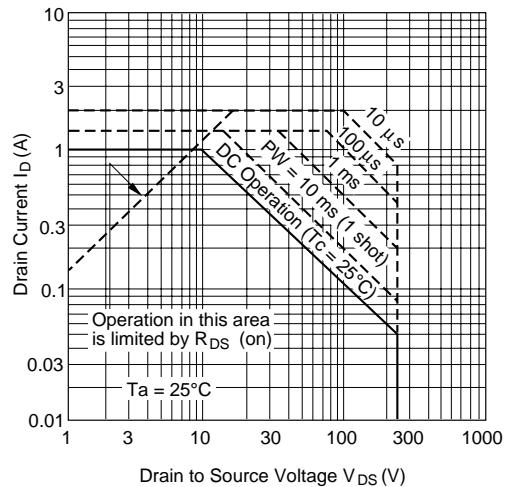
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	250	—	—	V	I _D = 10 mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR)GSS}	±30	—	—	V	I _G = ±100 µA, V _{DS} = 0
Gate to source leak current	I _{GSS}	—	—	±10	µA	V _{GS} = ±25 V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	100	µA	V _{DS} = 200 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	2.0	—	3.0	V	V _{DS} = 10 V, I _D = 1 mA
Forward transfer admittance	y _{fs}	0.3	0.5	—	S	V _{DS} = 10 V, I _D = 0.5 A ^{*1}
Static drain to source on state resistance	R _{DS(on)}	—	5.5	8.0	—	I _D = 0.5 A, V _{GS} = 10 V ^{*1}
Input capacitance	C _{iss}	—	60	—	pF	V _{DS} = 10 V, V _{GS} = 0,
Output capacitance	C _{oss}	—	30	—	pF	f = 1 MHz
Reverse transfer capacitance	C _{rss}	—	5	—	pF	
Turn-on delay time	t _{d(on)}	—	5	—	ns	V _{GS} = 10 V, I _D = 0.5 A,
Rise time	t _r	—	6	—	ns	R _L = 60
Turn-off delay time	t _{d(off)}	—	10	—	ns	
Fall time	t _f	—	4.5	—	ns	
Body to drain diode forward voltage	V _{DF}	—	0.96	—	V	I _F = 1 A, V _{GS} = 0
Body to drain diode reverse recovery time	t _r	—	160	—	ns	I _F = 7 A, V _{GS} = 0, di _F /dt = 100 A/µs

Note 1. Pulse test

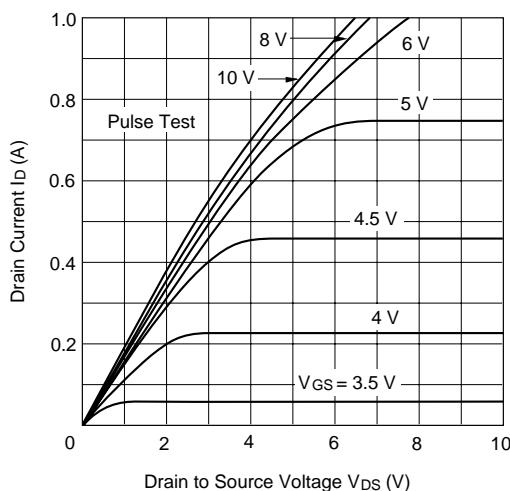
Power vs. Temperature Derating



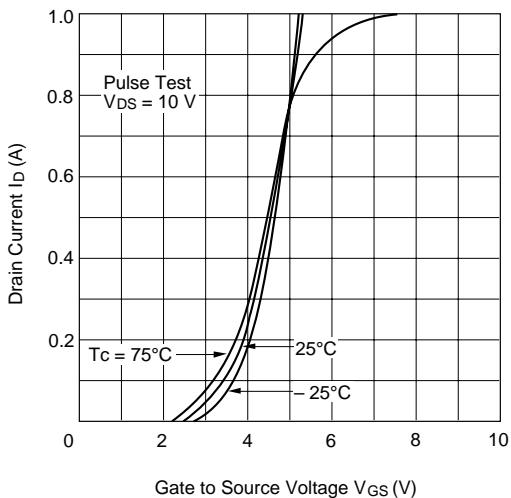
Maximum Safe Operation Area



Typical Output Characteristics

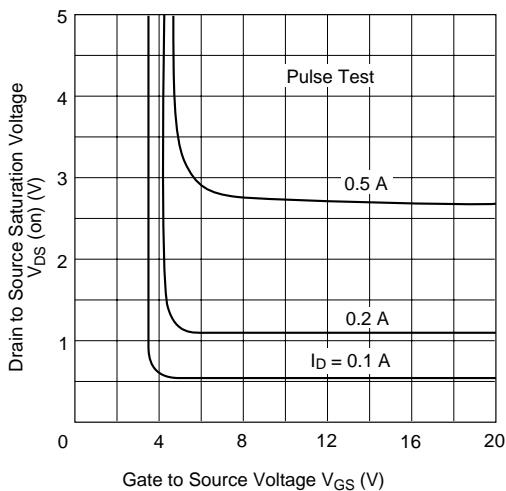


Typical Transfer Characteristics

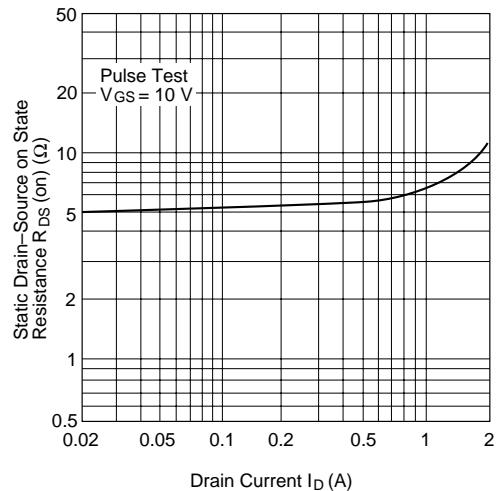


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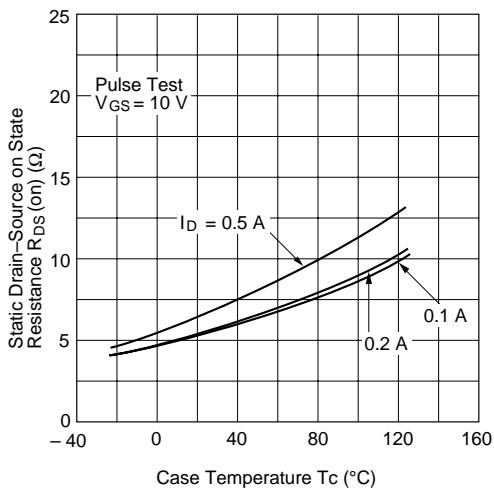
Drain to Source Saturation Voltage
vs. Gate to Source Voltage



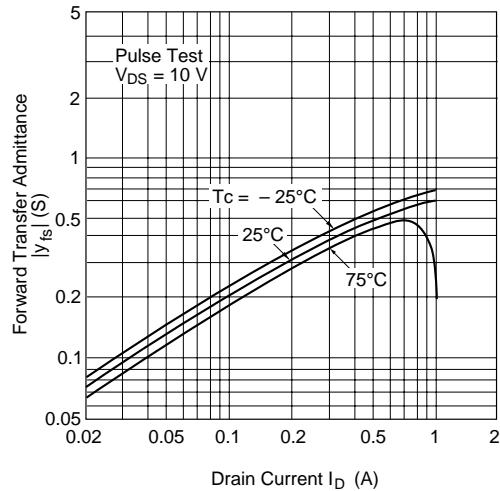
Static Drain to Source on State
Resistance vs. Drain Current



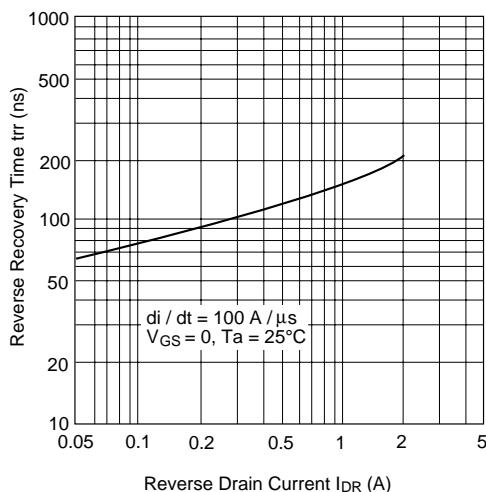
Static Drain to Source on State
Resistance vs. Temperature



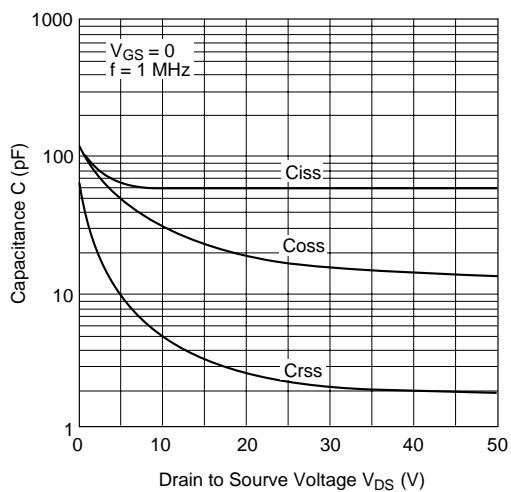
Forward Transfer Admittance
vs. Drain Current



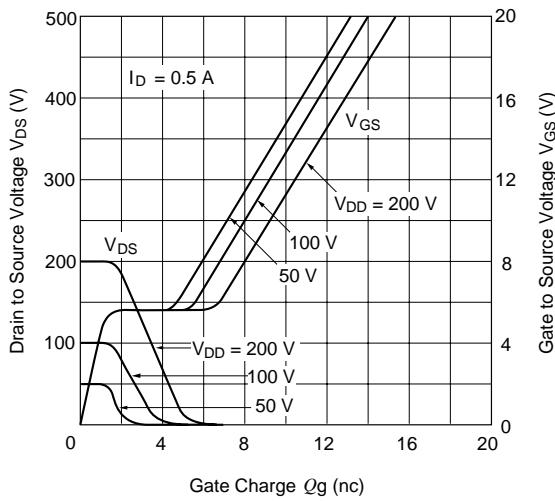
Body to Drain Diode Reverse Recovery Time



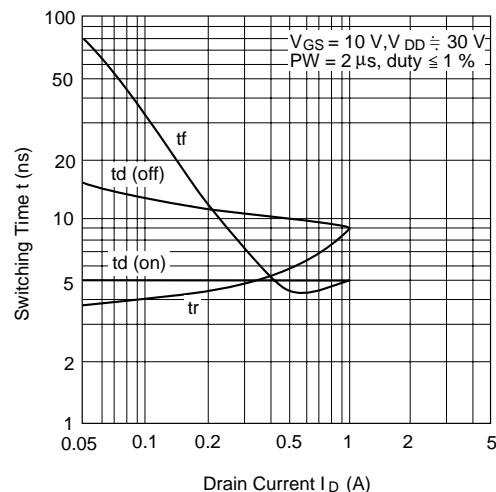
Typical Capacitance vs. Drain to Source Voltage



Dynamic Input Characteristics

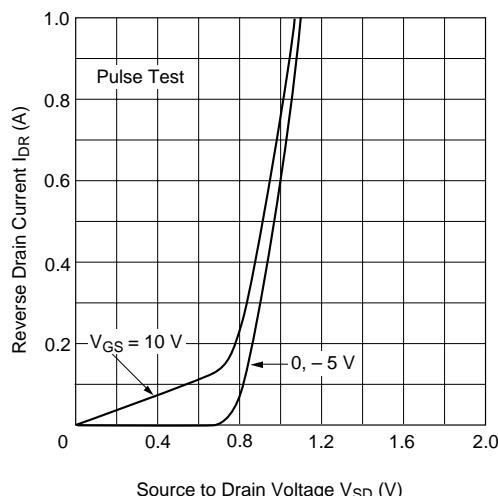


Switching Characteristics

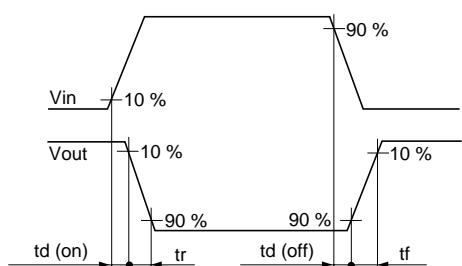
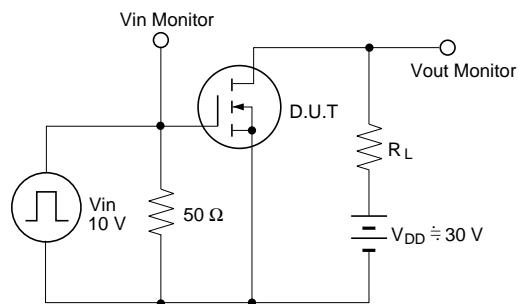
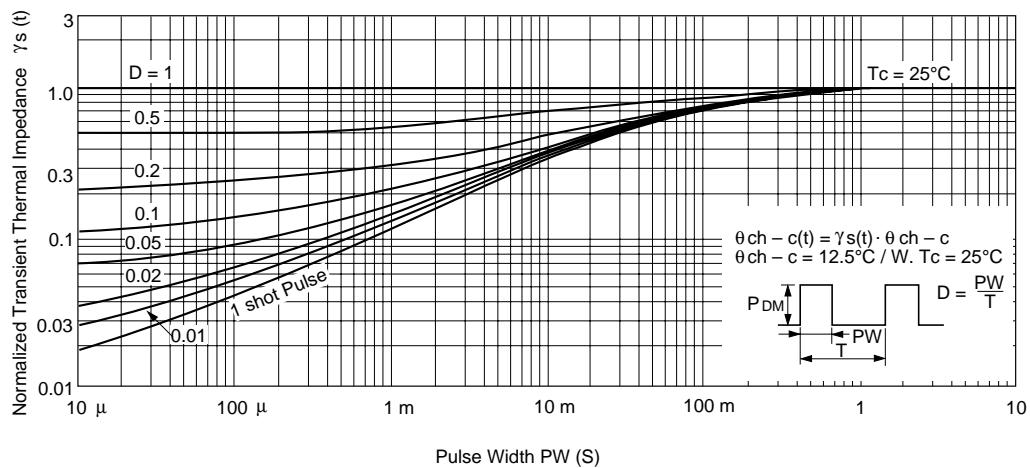


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Reverse Drain Current
vs. Source to Drain Voltage



Normalized Transient Thermal Impedance vs. Pulse Width



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